



Technical Query

Primary Contact Information

Viasystems Technologies Corp.,
L.L.C., a member of TTM
Technologies Group
8150 Sheppard Ave E

To: _____
 Email: smith@debron-electronics.com
 Phone: 248-588-7220 ext. 221

Secondary Contact Information

To: _____
 Email: _____
 Phone: _____

Date: 3/17/2017

Viasystems Contacts	Primary	Secondary	Field Application Engineer
Customer Service:	Teri Mirza	Dennis Hanley	Todd Henninger
Phone:			763-424-1892
e-mail:	Teri.Mirza@viasystems.com	Dennis.Hanley@viasystems.co	Todd.Henninger@viasystems.com
Technical Support:	Kirti Patel		
Phone:	416-208-2100		
e-mail:	Kirti.Patel@ttm.com		

PLEASE, COPY ALL ABOVE ON ALL CORRESPONDENCES

Customer Name:	DEBRON INDUSTRIAL ELECTRONICS
Customer P/N:	40-00624-00LF
Rev #:	-
Site Tooling P/N:	170892
Viasystems P/N:	
Order Type:	Manufacturing Build

Site : TO

Data

Issue #	Status	Issue	Proposed Resolution	Customer Response	Links
1	On Hold- Not Started	We have moved the via hole at R958 up by 30 mil to avoid being cut by milling on solder side. We changed the milling to stop 7.5 mm from the left side board edge as shown in the image. It would pass the breakoff tab with your suggested 20 mm distance. Please advise if this is acceptable or not.			Image
2	On Hold- Not Started	Attached please find the edited gerber files for your review and approval.			